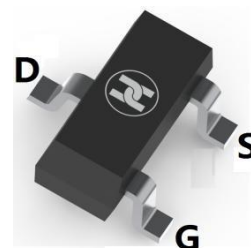
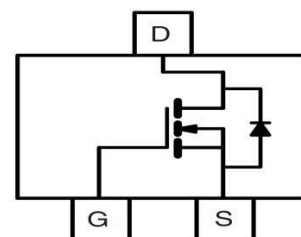


HIGH VOLTAGE MOSFET (N-CHANNEL)
FEATURES

- $V_{DS}=100V, R_{DS(ON)}=6\Omega @ V_{GS}=10V, I_D=0.17A$
- High Density Cell Design for Extremely Low $R_{DS(ON)}$
- Voltage Controlled Small Signal Switch
- For Small Servo Motor Controls, Power MOSFET Gate Drivers And Switching Applications
- Surface Mount device


SOT-23

MECHANICAL DATA

- Case: SOT-23
- Case Material: Molded Plastic. UL flammability
- Classification Rating: 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Weight: 0.008 grams (approximate)

MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-source voltage	V_{DS}	100	V
Gate-source voltage	V_{GS}	± 20	V
Continuous drain current	I_D	0.17	A
Pulsed drain current	I_{DM}	0.68	A
Continuous Source-Drain Diode Current	I_S	0.17	A
Power dissipation	P_D	0.35	W
Thermal resistance from Junction to ambient	$R_{\theta JA}$	357	$^\circ\text{C/W}$
Junction temperature	T_J	150	$^\circ\text{C}$
Storage temperature	T_{STG}	-55 ~ +150	$^\circ\text{C}$
Lead Temperature for Soldering Purposes(1/8" from case for 10 s)	T_L	260	$^\circ\text{C}$

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise specified)

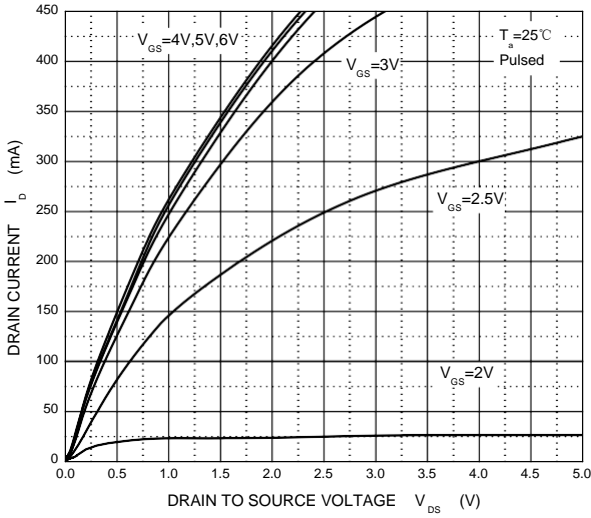
Parameter	Symbol	Min	Typ	Max	Unit	Conditions
STATIC CHARACTERISTICS						
Drain-Source breakdown voltage	$V_{(BR)DSS}$	100			V	$V_{GS}=0V, I_D=250\mu A$
Zero gate voltage drain current	I_{DSS}			1	μA	$V_{DS}=100V, V_{GS}=0V$
				10	nA	$V_{DS}=20V, V_{GS}=0V$
Gate-body leakage current	I_{GSS}			± 50	nA	$V_{DS}=0V, V_{GS}=\pm 20V$
Gate-threshold voltage (note 1)	$V_{GS(th)}$	1	1.6	2.8	V	$V_{DS}=V_{GS}, I_D=250\mu A$
Drain-source on-resistance (note 1)	$R_{DS(ON)}$		3.8	10	Ω	$V_{GS}=4.5V, I_D=0.17A$
			3.5	6	Ω	$V_{GS}=10V, I_D=0.17A$
Forward trans-conductance (note 1)	g_{FS}	80			mS	$V_{DS}=10V, I_D=0.17A$
Diode forward voltage	V_{SD}			1.3	V	$I_S=0.34A, V_{GS}=0V$
DYNAMIC CHARACTERISTICS						
Input capacitance	C_{iss}		29	60	pF	$V_{DS}=25V, V_{GS}=0V, f=1MHz$
Output capacitance	C_{oss}		10	15	pF	
Reverse transfer capacitance	C_{rss}		2	6	pF	
SWITCHING CHARACTERISTICS						
Turn-on delay time	$t_{d(on)}$			8	nS	$V_{DD}=30V, V_{GS}=10V, R_{GEN}=50\Omega, I_D=0.28A$
Turn-on rise time	t_r			8	nS	
Turn-off delay time	$t_{d(off)}$			13	nS	
Turn-off fall time	t_f			16	nS	
Total gate charge	Q_g		1.4	2	nC	$V_{DS}=10V, V_{GS}=10V, I_D=0.22A$
Gate-source charge	Q_{gs}		0.15	0.25	nC	
Gate-drain charge	Q_{gd}		0.2	0.4	nC	

Note:1. Pulse test ; Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$.

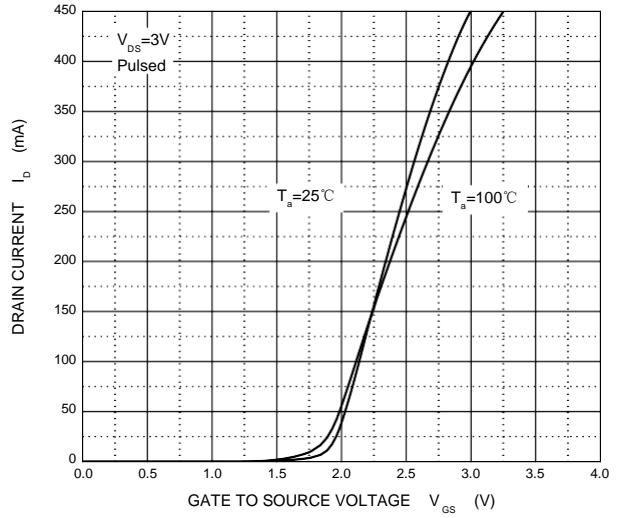
HIGH VOLTAGE MOSFET (N-CHANNEL)

Typical Characteristics

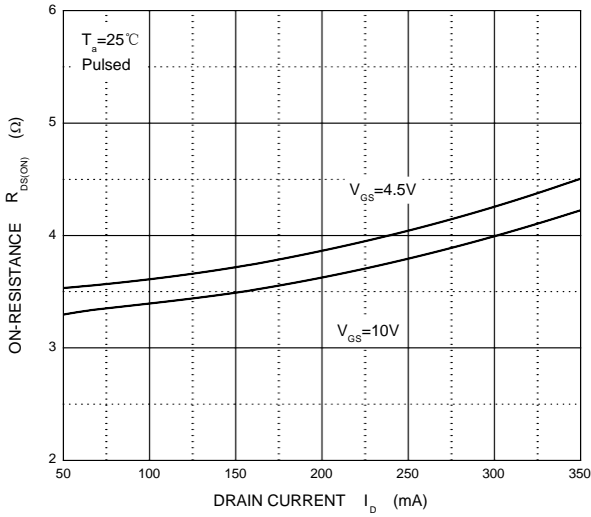
Output Characteristics



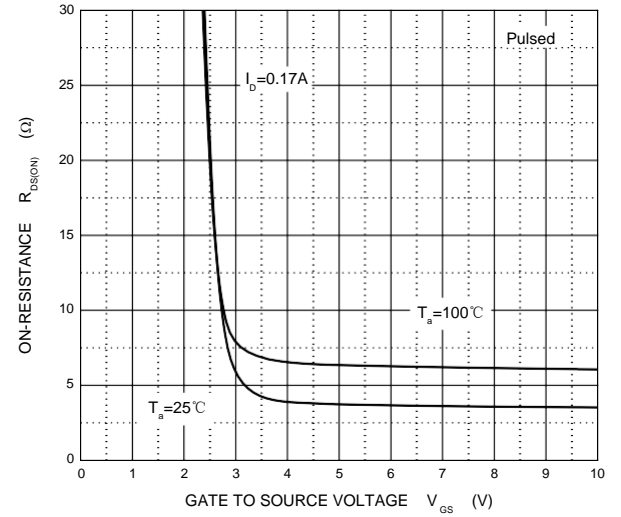
Transfer Characteristics



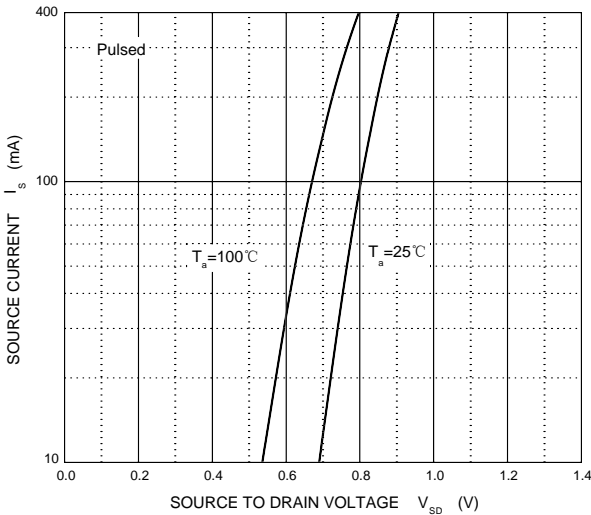
$R_{DS(ON)}$ — I_D



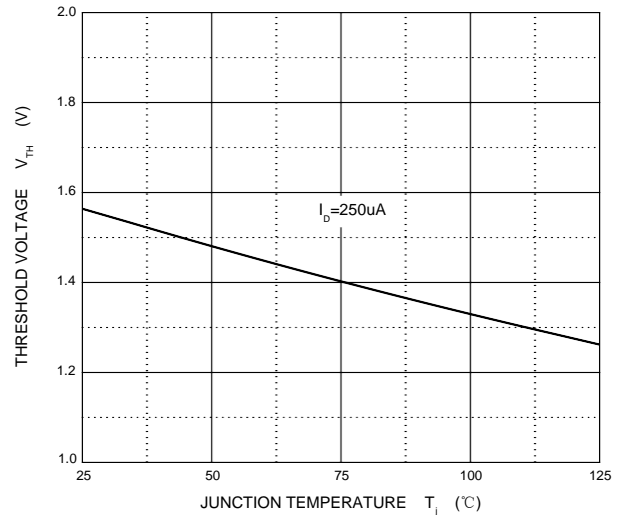
$R_{DS(ON)}$ — V_{GS}

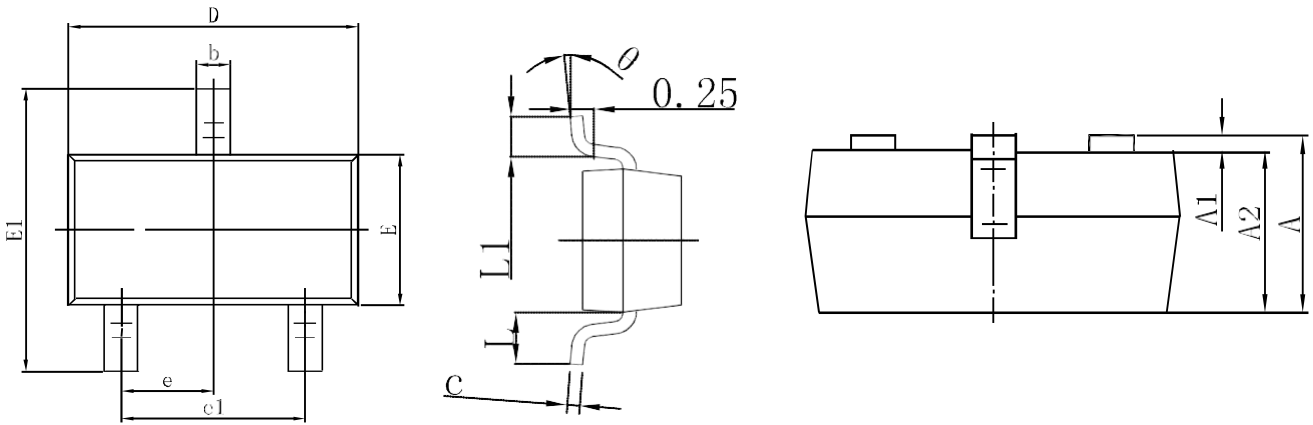


I_S — V_{SD}

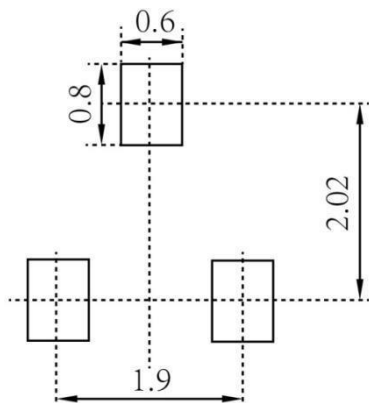


Threshold Voltage

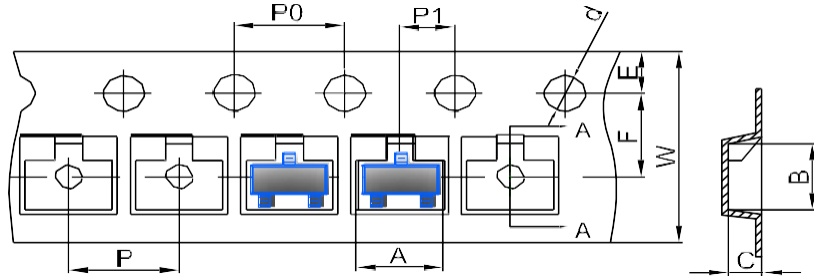


HIGH VOLTAGE MOSFET (N-CHANNEL)
SOT-23 Package Outline Dimensions


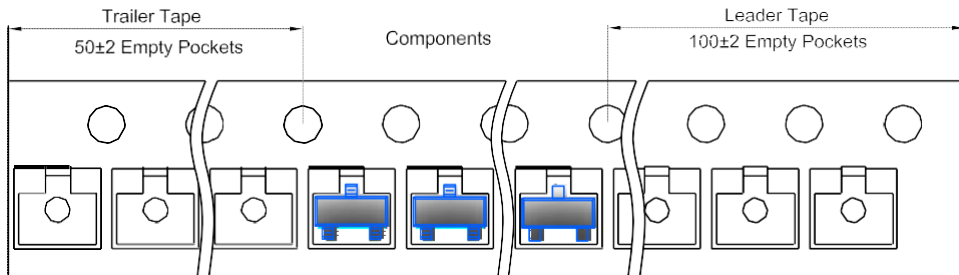
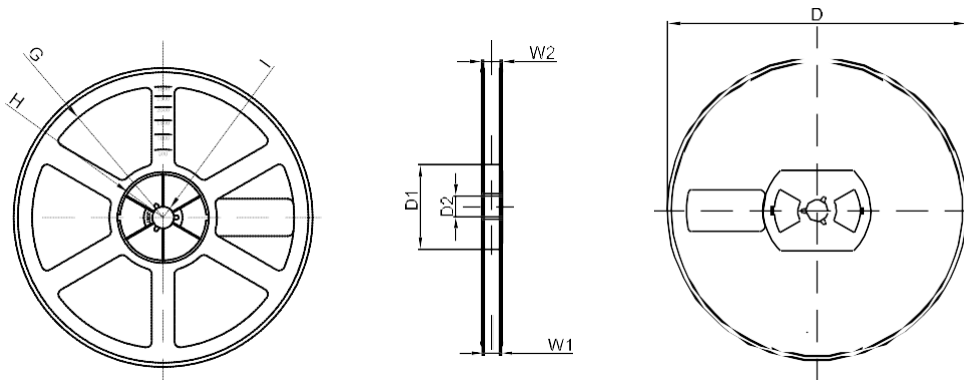
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

SOT-23 Suggested Pad Layout

Note:

1. Controlling dimension: in millimeters
2. General tolerance: $\pm 0.05\text{mm}$
3. The pad layout is for reference purposes only

HIGH VOLTAGE MOSFET (N-CHANNEL)
SOT-23 Tape and Reel
SOT-23 Embossed Carrier Tape


DIMENSIONS ARE IN MILLIMETER										
TYPE	A	B	C	d	E	F	P0	P	P1	W
SOT-23	3.15	2.77	1.22	Ø1.50	1.75	3.50	4.00	4.00	2.00	8.00
TOLERANCE	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1

SOT-23 Tape Leader and Trailer

SOT-23 Reel


DIMENSIONS ARE IN MILLIMETER								
REEL OPTION	D	D1	D2	G	H	I	W1	W2
7" DIA	Ø178	54.40	13.00	R78	R25.60	R6.50	9.50	12.30
TOLERANCE	±2	±1	±1	±1	±1	±1	±1	±1